DATE: February 14, 2022

EXPECTED PCN SHIP DATE: February 14, 2022



Quality Assurance 160 Rio Robles San Jose, CA 95134

www.maxim integrated.com

	PROCESS CHANGE NOTICE
X	PRODUCT CHANGE NOTICE

ANALOG DEVICES HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES:								
X DESIGN	X WAFER FAB	ASSEMBL		TEST	ELEC/MECH SPECS			
AFFECTED PRODUCT:								
Ordering P/N: (See PN listing XLS in PCN ZIP file)								
CHANGE FROM		CHANGE TO: -						
1. MAX17552ATB+/MAX17552AUB+ (Step-Down DC-DC								
Converter ICs)								
Current die revision		New revised die PI24A-1B at Epson						
PI24A-0E has a re		This design revision will be an OTP option that enhances the						
non-switching state. This may happen if MODE pin transitions			robustness of these devices, and resolves the non-switching					
on the fly in phase relation with the LX (Inductor Connection)			locked state, when MODE signal is changed on the fly, during normal LX (Inductor Connection) switching operations.					
switching activity		normai LX	(Inductor Conne	ection) switching operations.				
2 MAX17530/17	531/17532/17550/17552 ((Ste	en-Down DC-DC						
Converter ICs)	751/11/552/11/550/11/552 ((Sic	p-Down DC-DC						
· · · · · · · · · · · · · · · · · · ·	akata/Japan using	Expanding waferfab supply source to Powerchip/Taiwan						
Current source for wafer fabrication at Epson/Sakata/Japan using S18 process technology			(Fab101): uses same S18 process technology and includes the die					
process teems	510 process technology			upgrade for the MAX17552 described above.				
JUSTIFICATION: -								
1. This design revision change enhances the robustness of these devices, and resolves the non-switching locked state, when MODE								
signal is changed on the fly, during normal LX (Inductor Connection) switching operations.								
2. Adding Fab101 to expand wafer capacity and ensure supply continuity.								
Fab101 S18 process successfully passed ADI qualification requirements (see attachment ref. FAB101_S18U).								
There are no other changes to Form/Fit/Function of these devices.								
TDACEADIIITV	TRACEABILITY: Analog Device maintains full traceability by device marking, packaging labels and shipment documents.							
TRACEADILIT 1. Analog Device maintains run traceability by device marking, packaging labers and simplifient documents.								

Analog Devices's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

Nasser Ali Chaosche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

**Contact your local Analog Devices Company Representative** 

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Document Title: Product Change Notice - Notification Only

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